

L Number	Hits	Search Text	DB	Time stamp
53	49	flexible near pcb and heat near sink	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 15:29
54	3145	pcb and heat near sink	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 15:29
55	20	pcb and heat near sink and bonding adj film	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 15:36
56	0	20030019568.URPN.	USPAT	2004/09/27 15:31
57	5	("4691225" "5473514" "5583378" "5614443" "5671531").PN.	USPAT	2004/09/27 15:34
58	0	20030019568.URPN.	USPAT	2004/09/27 15:35
59	3145	pcb and heat near sink	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 15:37
60	2549	pcb and printed adj circuit and heat near sink	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 15:37
61	2540	pcb and printed adj circuit and heat adj sink	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 15:37
62	1091	pcb and printed adj circuit and heat adj sink and bonding	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 15:38
63	91	pcb and printed adj circuit and heat adj sink and adhesive near bonding	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 15:44
64	1248	McCutcheon near Jeffrey W. inv.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 15:43

65	1	McCutcheon near Jeffrey. inv.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 15:43
66	20	flexible adj printed adj circuit and heat adj sink and adhesive near bonding	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 15:57
67	3	flexible adj printed adj circuit and heat adj sink and adhesive near bonding and (174/88R; 174/94R ; 174/259 ; 174/257 ; 174/258 ; 174/254 ; 174/255 ; 174/262 ; 174/264 ; 174/265 ; 174/266 ; 156/150 ; 156/151 ; 156/252 ; 156/277 ; 156/299 ; 156/300 ; 156/306.9 ; 156/307.7 ; 156/309.6 ; 361/749 ; 361/792 ; 29/830 ; 427/97).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 16:01
68	16	("4783695" "4820781" "5106667" "5157589" "5219640" "5232548" "5237205" "5298331" "5359496" "5434751" "5480841" "5552222" "5728473" "5734008" "5795162" "5859181").PN.	USPAT	2004/09/27 15:59
69	13	laminate adj heat near sink and circuit adj board	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 16:11
70	7	("5332695" "5561321" "5675474" "5786633" "6046907" "6081426" "6188579").PN.	USPAT	2004/09/27 16:08
71	1	laminate adj heat near sink and flexible near circuit and heating	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 16:17
72	0	laminate adj heat near sink and pcb and heating	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 16:17
73	59	heat near sink and laminating and pcb and heating	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 16:29

74	19	("3244795" "4087300" "4388129" "4421827" "4465538" "4510008" "4642160" "4803022" "4927477" "5296651" "5360887" "5362534" "5382757" "5455393" "5478972" "5481795" "5496971" "5544773" "5550325").PN.	USPAT	2004/09/27 16:24
75	8	heat near sink and laminating and pcb and heating and 29/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT	2004/09/27 16:34
76	18	("4012832" "4075388" "4242157" "4436242" "4664739" "4818823" "4936010" "5072874" "5137836" "5146981" "5182852" "5253010" "5268048" "5451285" "5471027" "5601675" "5616958" "5632438").PN.	USPAT	2004/09/27 16:31
77	15	("3405323" "4069498" "4092697" "4193445" "4254431" "4462462" "4498119" "4561011" "4639829" "4682269" "4794981" "4879632" "4965699" "4974119" "5012858").PN.	USPAT	2004/09/27 16:32
78	140	heat near sink and laminating and (29/830; 29/840 ; 29/841 ; 29/832 ; 438/15 ; 438/119 ; 438/4 ; 257/717 ; 257/700 ; 257/738 ; 257/706 ; 257/701 ; 257/707 ; 257/787 ; 257/796 ; 156/94 ; 156/297).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 16:48
79	8	("4770953" "5011732" "5130498" "5145540" "5213877" "5529852" "5616421" "5675474").PN.	USPAT	2004/09/27 16:40
80	7	Fraivillig near James .inv.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 16:48